

# HIGH SPEED NPN SILICON PLANAR EPITAXIAL SATURATED SWITCHING TRANSISTORS

- High  $f_T$ : 650 MHz, typ.
- High Gain: 40 min. @  $I_C = 10\text{mA}$
- Low  $C_{ob}$ : 4pf max. @  $V_{CB} = 5\text{V}$
- Low  $T_{on} = 9\text{ nsec typ.}$
- Low  $t_{off} = 13\text{ nsec typ.}$

The ITT 2N2368 and 2N2369 are NPN silicon planar epitaxial saturated switching transistors for applications at current ranges from 0.1 to 100 mA. High gain and narrow base region provide excellent radiation resistance. They can operate at clock rates above 10MHz for commercial computer applications.

### ABSOLUTE MAXIMUM RATINGS

CHARACTERISTICS		UNITS
Collector-to-Base Voltage.....	40	Volts
Collector-to-Emitter Voltage (shorted base) ..	40	Volts
Collector-to-Emitter Voltage (open base).....	15	Volts
Emitter-to-Base Voltage.....	4.5	Volts
Collector Current (10 sec. pulse).....	500	mA
Junction Temperature (op. and stg.).....	-65 to +200	$^{\circ}\text{C}$
Total Power Dissipation @ $T_C = 25^{\circ}\text{C}$ .....	1.2	Watts
(derate 6.8 mW/ $^{\circ}\text{C}$ above $25^{\circ}\text{C}$ )		
	@ $T_C = 100^{\circ}\text{C}$ .....	0.68
Total Power Dissipation @ $T_A = 25^{\circ}\text{C}$ .....	0.36	Watts
(derate 2.06 mW/ $^{\circ}\text{C}$ above $25^{\circ}\text{C}$ )		

### ELECTRICAL CHARACTERISTICS @ $25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Min.	Typ.	Max.	Unit	Conditions
$h_{FE}^1$	20		60		$I_C = 10\text{mA}, V_{CE} = 1\text{V}$ 2N2368
	40		120		
	10				$I_C = 10\text{mA}, V_{CE} = 1\text{V}, T = -55^{\circ}\text{C}$ 2N2368
	20				
$V_{CE}(\text{sat})$		0.2	0.25	Vdc	$I_C = 10\text{mA}, I_B = 1\text{mA}$
		0.7	0.75	0.85	
$V_{BE}(\text{sat})$		0.1	0.4	A	$V_{CB} = 20\text{V}, I_E = 0$ $V_{CB} = 20\text{V}, I_E = 0, T = 150^{\circ}\text{C}$
			10	30	
$f_T$		650		MHz	$V_{CE} = 10\text{V}, I_C = 10\text{mA}$
$C_{ob}$		2.5	4.0	pf	$V_{CB} = 5\text{V}, I_E = 0$
$s^2$ (charge storage time)			10	nsec	$I_C = I_{B1} 10\text{mA}, 10\text{mA},$ $I_{B2} -10\text{mA} - 10\text{mA}$ 2N2368
			13	nsec	

# 2N2368, 2N2369

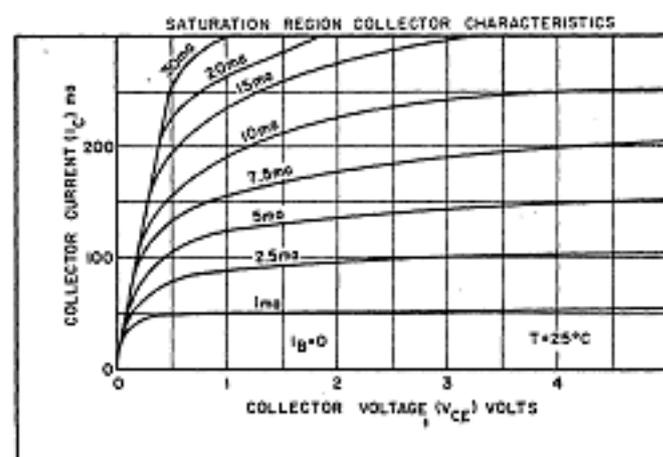
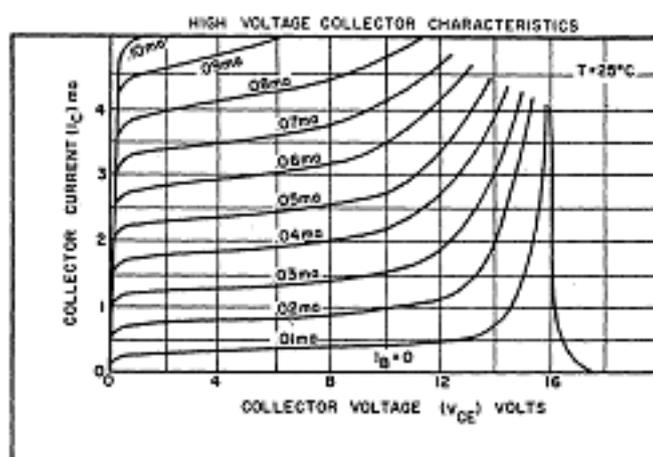
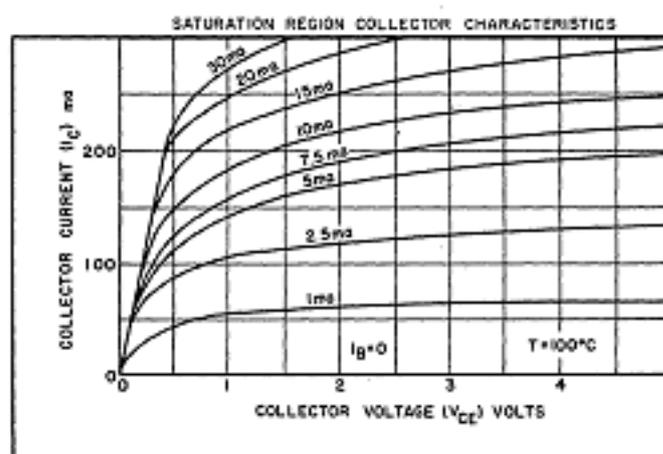
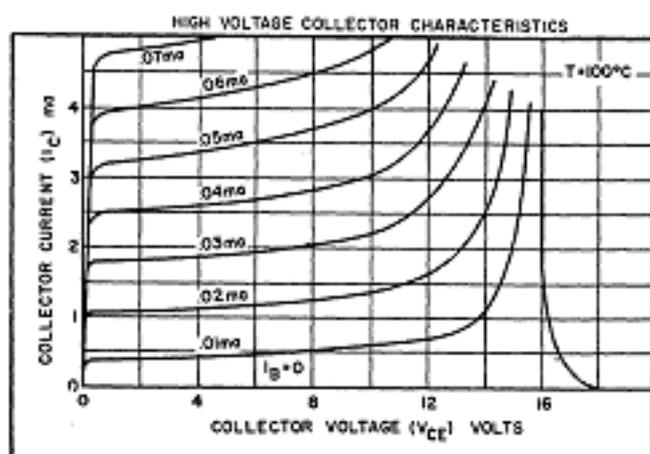
## SILICON SWITCHING TRANSISTORS

**ELECTRICAL CHARACTERISTICS @ 25°C unless otherwise noted. (continued)**

Symbol	Min.	Typ.	Max.	Unit	Conditions
$t_{on}^2$		9.0	12	nsec	$I_C$ 10mA, $I_{B1}$ 3mA
$t_{off}^2$		10 13	15 18	nsec nsec	$I_C$ 10mA, $I_{B1}$ 3mA, $I_{B2}$ -1.5mA 2N2368 2N2369
$BV_{CBO}$	40			Vdc	$I_C = 10$ A, $I_E = 0$
$BV_{CES}$	40			Vdc	$I_C = 10$ A, $I_B = 0$
$V_{CE0}$ (sust)	15			Vdc	$I_C = 10$ mA, $I_B = 0$
$BV_{EBO}$	4.5			Vdc	$I_E = 10$ A, $I_C = 0$

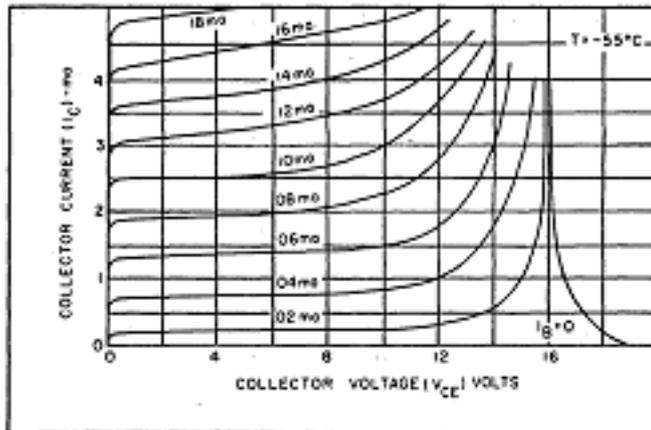
NOTES: 1. Pulse measurement: width 300 sec, duty cycle 2%.  
2. Pulse switching circuits for exact  $I_C$ ,  $I_{B1}$ , and  $I_{B2}$ .

### TYPICAL CHARACTERISTICS'

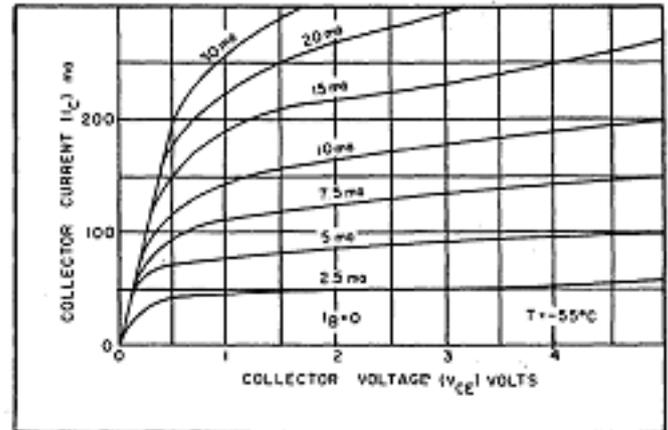


TYPICAL CHARACTERISTICS, continued

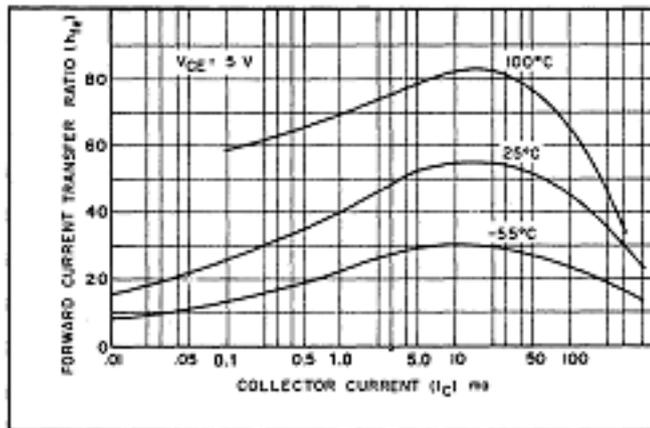
HIGH VOLTAGE COLLECTOR CHARACTERISTICS



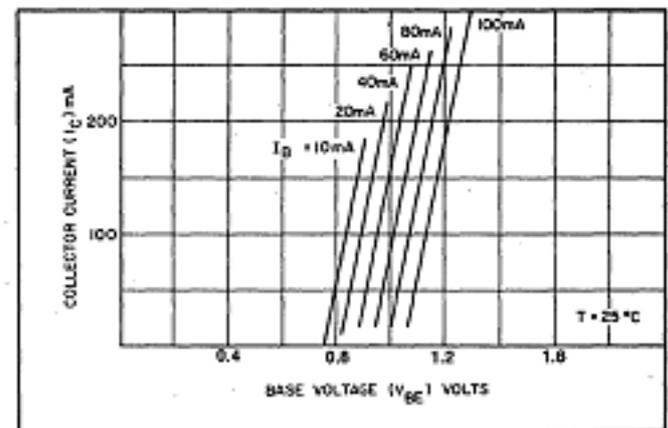
SATURATION REGION COLLECTOR CHARACTERISTICS



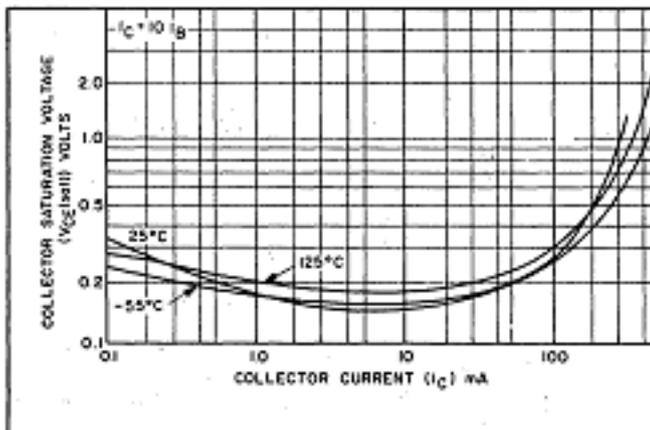
PULSE DC CURRENT GAIN VS COLLECTOR CURRENT



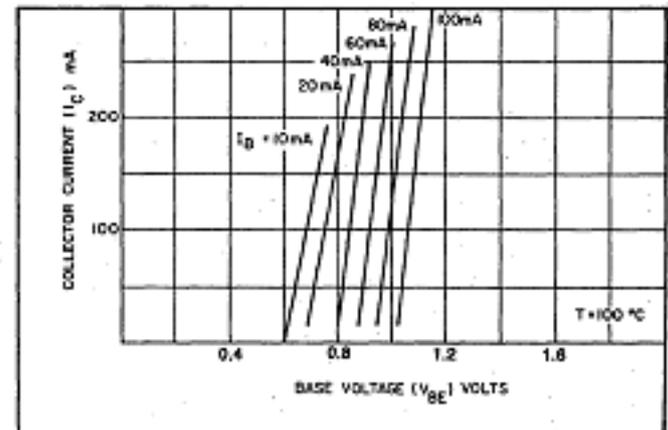
SATURATION REGION BASE CHARACTERISTICS



COLLECTOR SATURATION VOLTAGE VERSUS COLLECTOR CURRENT



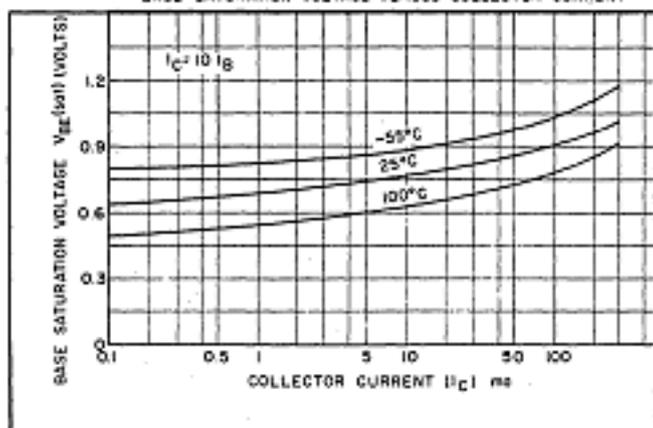
SATURATION REGION BASE CHARACTERISTICS



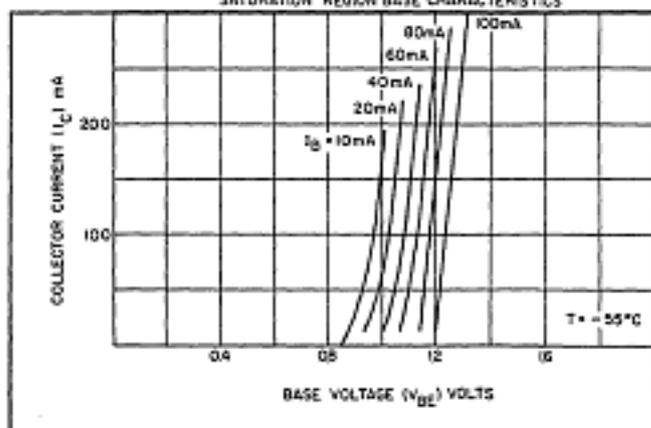
# 2N2368, 2N2369 SILICON SWITCHING TRANSISTORS

## TYPICAL CHARACTERISTICS, continued

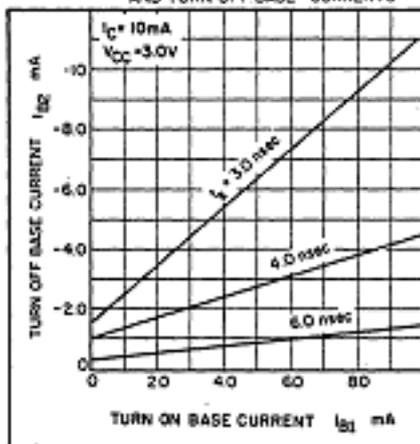
BASE SATURATION VOLTAGE VERSUS COLLECTOR CURRENT



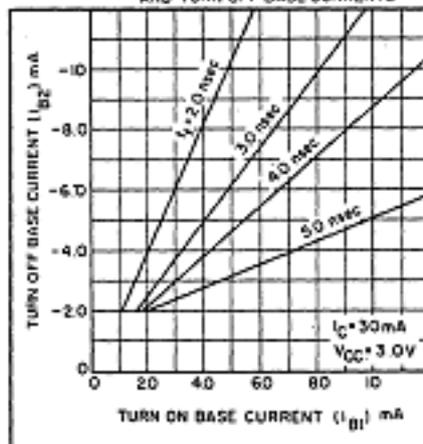
SATURATION REGION BASE CHARACTERISTICS



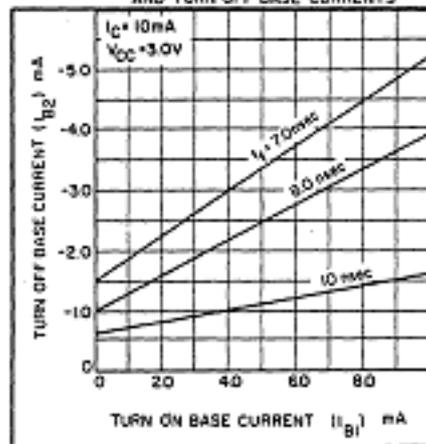
STORAGE TIME VERSUS TURN ON AND TURN OFF BASE CURRENTS



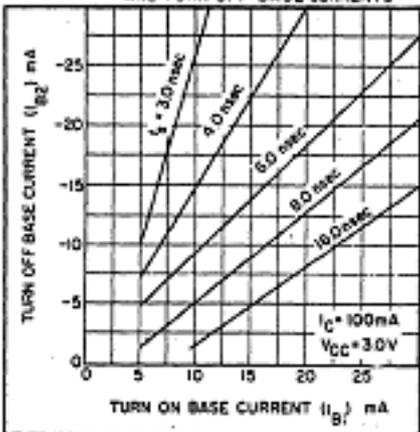
FALL TIME VERSUS TURN ON AND TURN OFF BASE CURRENTS



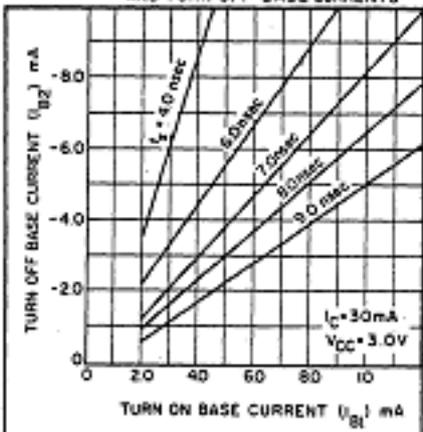
FALL TIME VERSUS TURN ON AND TURN OFF BASE CURRENTS



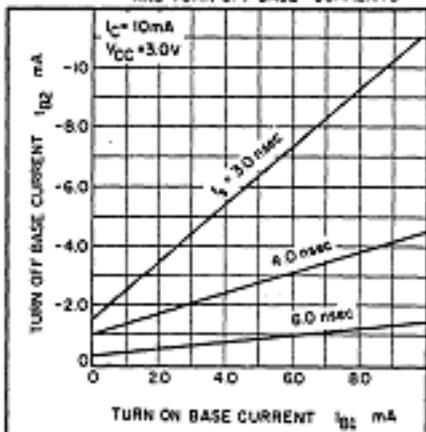
STORAGE TIME VERSUS TURN ON AND TURN OFF BASE CURRENTS



STORAGE TIME VERSUS TURN ON AND TURN OFF BASE CURRENTS



STORAGE TIME VERSUS TURN ON AND TURN OFF BASE CURRENTS



TYPICAL CHARACTERISTICS, continued

